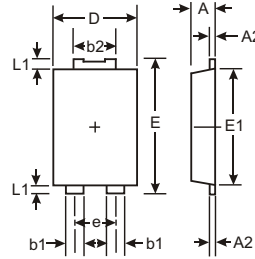


Features

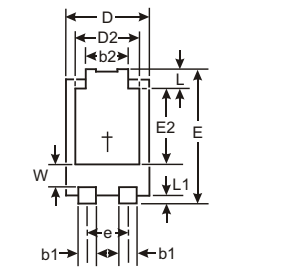
- Guard Ring Die Construction for Transient Protection
- Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- High Forward Surge Current Capability
- Lead Free Finish, RoHS Compliant (Note 1)**
- "Green" Molding Compound (No Br, Sb)**
- Qualified to AEC-Q101 Standards for High Reliability**



PowerDI 5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.05 NOM	
E	6.40	6.60
e	1.84 NOM	
E1	5.30	5.45
E2	3.55 NOM	
L	0.75	0.95
L1	0.50	0.65
W	1.20	1.50
All Dimensions in mm		

Mechanical Data

- Case: PowerDI 5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Polarity: See Diagram
- Marking: See Page 3
- Weight: 0.094 grams (approximate)



LEFT PIN ○ RIGHT PIN ○ BOTTOMSIDE HEAT SINK

Note: Pins Left & Right must be electrically connected at the printed circuit board.

Maximum Ratings @ T_A = 25 C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	35	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	25	V
Average Rectified Output Current (See also figure 5)	I _O	8	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	120	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R _{JS}		3.0	C/W
Thermal Resistance Junction to Ambient Air (Note 2) T _A = 25°C	R _{JA}	100		C/W
Thermal Resistance Junction to Ambient Air (Note 3) T _A = 25°C	R _{JA}	65		°C/W
Thermal Resistance Junction to Ambient Air (Note 4) T _A = 25°C	R _{JA}	45		°C/W
Operating Temperature Range	T _J	-65 to +125		°C
Storage Temperature Range	T _{STG}	-65 to +150		°C

- Notes:
- RoHS revision 13.2.2003. High Temperature Solder Exemption Applied, see *EU Directive Annex Note 7*.
 - FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 - Polymide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.

Electrical Characteristics @ $T_A = 25\text{ C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	35			V	$I_R = 1\text{ mA}$
Forward Voltage	V_F		0.46	0.51 0.41	V	$I_F = 8\text{ A}, T_S = 25\text{ C}$ $I_F = 8\text{ A}, T_S = 125\text{ C}$
Reverse Leakage Current (Note 5)	I_R		0.05 7	1.4 35	mA	$T_S = 25\text{ C}, V_R = 35\text{ V}$ $T_S = 100\text{ C}, V_R = 35\text{ V}$

Notes: 5. Short duration test pulse used to minimize self-heating effect.

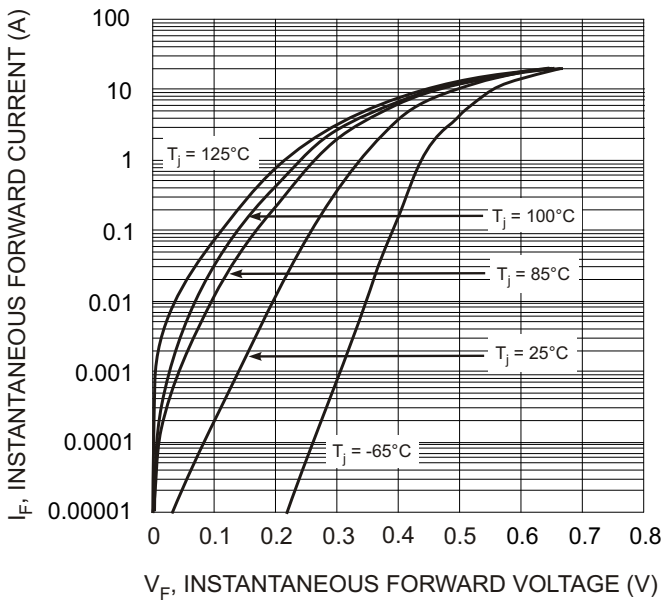


Fig. 1 Typical Forward Characteristics

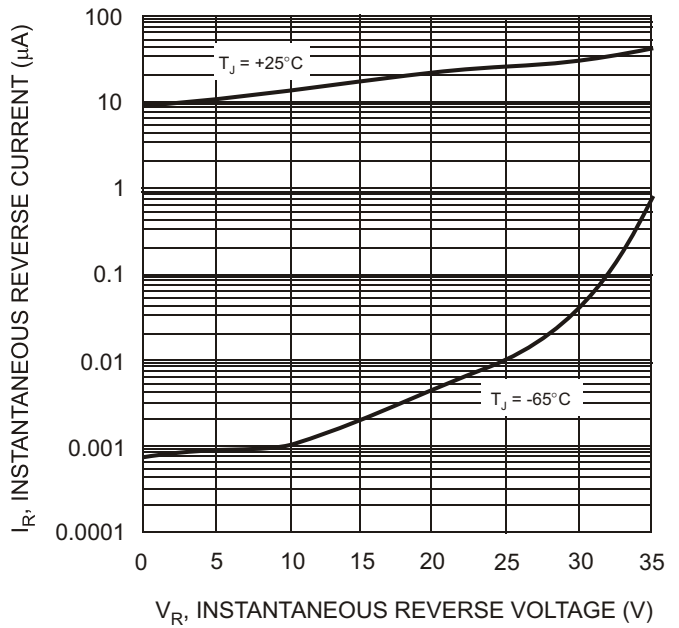


Fig. 2 Typical Reverse Characteristics

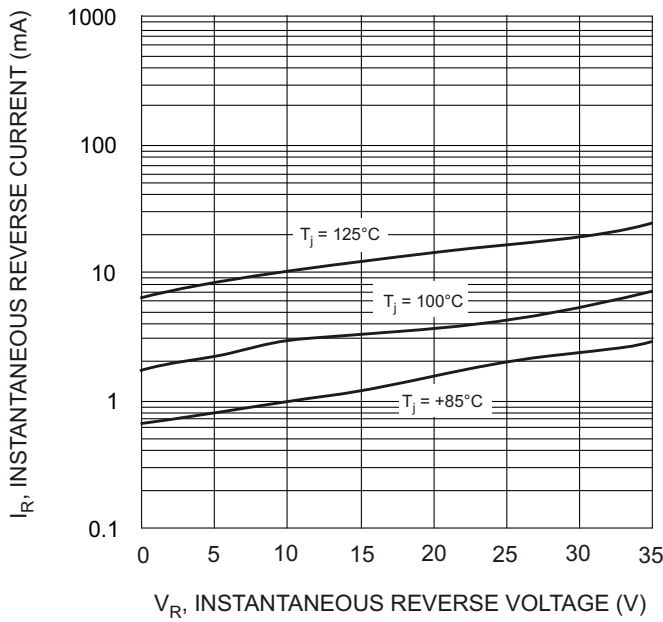


Fig. 3 Typical Reverse Characteristics

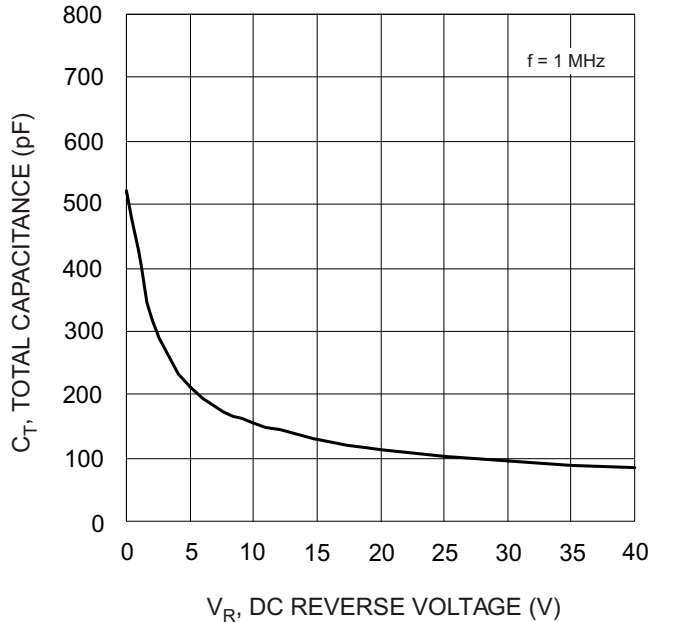


Fig. 4 Typical Total Capacitance vs. Reverse Voltage

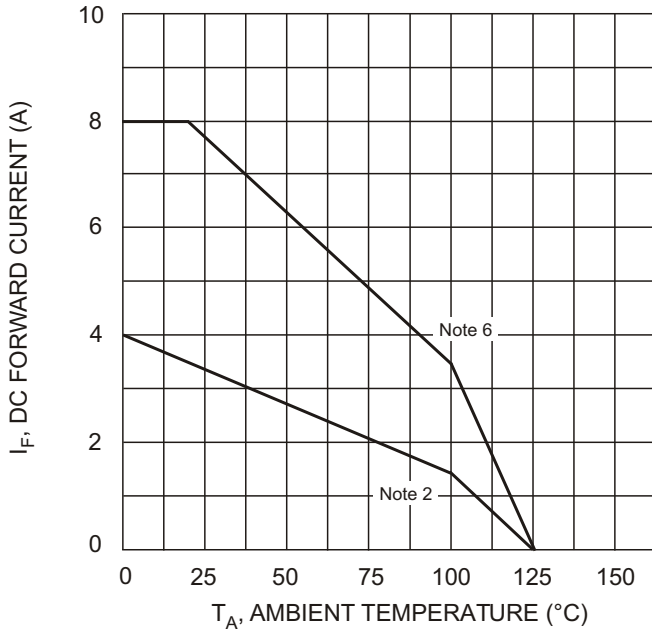


Fig. 5 DC Forward Current Derating

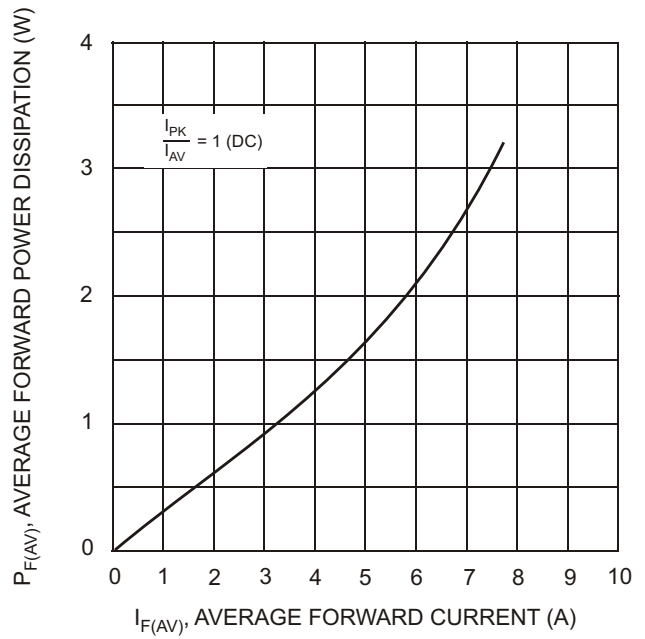


Fig. 6 Forward Power Dissipation

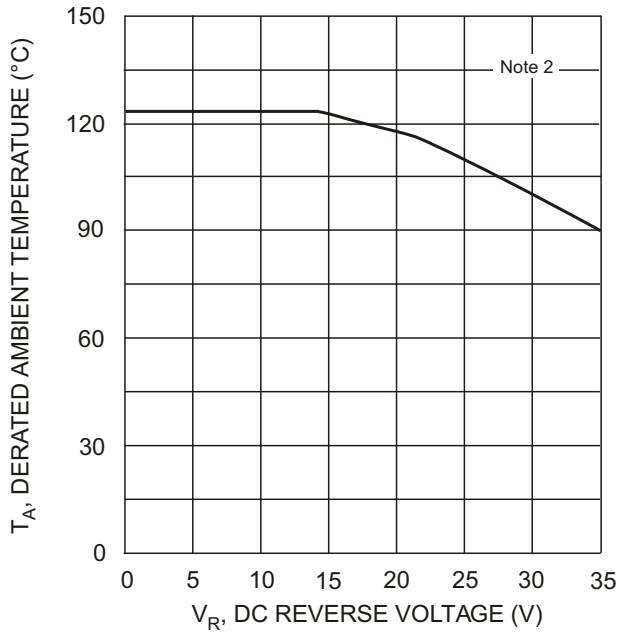


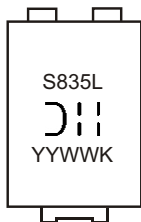
Fig. 7 Operating Temperature Derating

Ordering Information (Note 7)

Device	Packaging	Shipping
PDS835L-13	PowerDI 5	5000/Tape & Reel

- Notes:
- FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 - Polymide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 3.0mm.
 - For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



S835L = Product type marking code
 ⤵ = Manufacturers' code marking
 YYYY = Date code marking
 YY = Last two digits of year ex: 04 for 2004
 WW = Week code 01 to 52
 K = Factory Designator

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